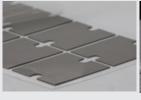


Technical Data Sheet

CR Technology offers a wide variety of thermally conductive pads also known as gap fillers. These materials are available in both silicone and non-silicone formulations.

EVERTHERM pads offer an endless range of thermal conductivity, softness and thickness, are naturally tacky and can be cut to any size or shape for easy installation





Material Properties

- · High thermal conductivity
- · Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

Applications

- ✓ Semiconductor heat sink
- ✓ Electric Vehicle (EV) Batteries
- Communication & power devises & modules
- ✓ LED lighting equipment
- ✓ Electronic components like: LEDs, CPUs, MOS • Mobiles, Laptops, Tablets



EVSF700

Color	Gray	Visual
Thickness	0.5 ~ 5.0mm	ASTM D374
Specific Gravity	3.40g/cm3	ASTM D792
Thermal Conductivity	7.0 W/m.k	ASTM D5470
Hardness(Shore oo)	40~80	ASTM D2240
Normal Hardness(Shore00)	40/60±5	ASTM D2240
Elongation	15%	ASTM D412
Tensile Strength	20psi	ASTM D412
Dielectric Breakdown Voltageh@AC	>6000V/mm	ASTM D149
Flammability Rating	UL94 V-0	E355606
Volume resistivity	1*1013Ω.cm	ASTM D257
Operating Temperature	-50-150	***
Thermal Resistance(1mm,@30psi)	0.29 *in2/W	ASTM D5470
Compression Ratio(1mm,@30psi)	30%	***
Dielectric Constant@1MHz	10.0	ASTM D150
RoHS	PASS	IEC 62321
Halogen	PASS	EN14582
REACH	PASS	EN14372

Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

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Note: The information provided herein is accurate at time of publication. It is the responsibility of the end-user to confirm compliance to their application. All test data is typical. Therefore, these recommendations and data are for reference only and not as a product warranty.